FFKDS/H-2,54 - PCB terminal block

1791826

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PCB terminal block, nominal current: 6 A, rated voltage (III/2): 160 V, nominal cross section: 0.5 mm^2, number of potentials: 1, number of rows: 1, number of positions per row: 1, product range: FFKDS(A) 0,5/..-H, pitch: 2.54 mm, connection method: Push-in spring connection, mounting: Wave soldering, conductor/PCB connection direction: 0 °, color: green, Pin layout: Linear pinning, Solder pin [P]: 3.4 mm, number of solder pins per potential: 2, type of packaging: packed in cardboard. Single module for the custom grouping of different numbers of positions. An end terminal block is also needed to terminate the block (see accessories). Blocked items with different numbers of positions are also available.

Your advantages

- Time saving push-in connection, tools not required
- Defined contact force ensures that contact remains stable over the long term
- Intuitive operation due to color-coded actuating push button
- Operation and conductor connection from one direction enable integration into front of device
- Two solder pins reduce the mechanical strain on the soldering spots
- The latching on the side enables various numbers of positions to be combined

Commercial data

Item number	1791826
Packing unit	250 pc
Minimum order quantity	250 pc
Sales key	AA11
Product key	AAKBBA
GTIN	4017918044459
Weight per piece (including packing)	0.56 g
Weight per piece (excluding packing)	0.547 g
Customs tariff number	85369010
Country of origin	GR

Technical data

Product properties

Product type	PCB terminal block
Product family	FFKDS(A) 0,5/..-H
Product line	COMBICON Terminals XS
Type	PC terminal block can be aligned
Number of positions	1
Pitch	2.54 mm
Number of connections	1
Number of rows	1
Number of potentials	1
Pin layout	Linear pinning
Solder pins per potential	2

Fitting of components

Partial assembly	No

Electrical properties

Properties

Nominal current I_N	6 A
Nominal voltage U_N	160 V
Rated voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Type	PC terminal block can be aligned
Nominal cross section	0.5 mm²

Conductor connection

Connection method	Push-in spring connection
Conductor cross-section rigid	0.14 mm² ... 0.5 mm²
Conductor cross-section flexible	0.14 mm² ... 0.5 mm²
Conductor cross-section AWG	26 ... 20
Stripping length	11 mm

Mounting

Mounting type	Wave soldering

Pin layout	Linear pinning

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface terminal point (top layer)	Tin (5 µm - 7 µm Sn)
Metal surface terminal point (middle layer)	Nickel (2 µm - 3 µm Ni)
Metal surface soldering area (top layer)	Tin (5 µm - 7 µm Sn)
Metal surface soldering area (middle layer)	Nickel (2 µm - 3 µm Ni)

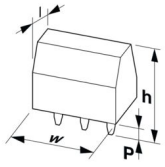
Material data - housing

Color (Housing)	green (6021)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Material data – actuating element

Color (Actuating element)	orange (2003)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Dimensions

Dimensional drawing	
Pitch	2.54 mm
Width [w]	5.04 mm

Height [h]	16 mm
Length [l]	13.6 mm
Installed height	12.6 mm
Solder pin length [P]	3.4 mm
Pin dimensions	0.5 x 0.8 mm

PCB design

Pin spacing	5.08 mm
Hole diameter	1.1 mm

Mechanical tests

Test for conductor damage and slackening

Specification	IEC 60999-1:1990-05
Result	Test passed

Pull-out test

Specification	IEC 60999-1:1990-05
Conductor cross-section/conductor type/tractive force setpoint/actual value	0.14 mm² / solid / > 7 N
	0.2 mm² / flexible / > 10 N
	0.5 mm² / solid / > 30 N
	0.5 mm² / flexible / > 30 N

Electrical tests

Temperature-rise test

Specification	IEC 60998-1:1990-04
Requirement temperature-rise test	Increase in temperature ≤ 45 K

Insulation resistance

Specification	IEC 60512-2:1985-00
Insulation resistance, neighboring positions	10^{12} Ω

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
minimum clearance value - non-homogenous field (III/3)	1.5 mm
minimum creepage distance (III/3)	1.6 mm
Rated insulation voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
minimum clearance value - non-homogenous field (III/2)	1.5 mm
minimum creepage distance (III/2)	1.5 mm
Rated insulation voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:1982 + AMD 2:1985
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Ambient conditions

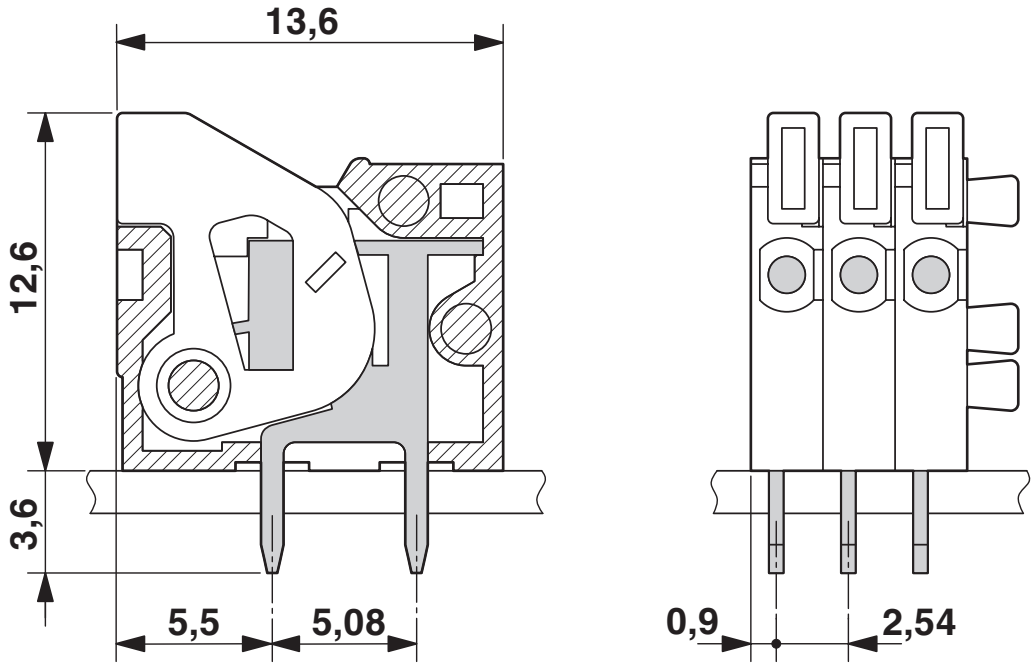
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 100 °C (Depending on the current carrying capacity/derating curve)

Packaging specifications

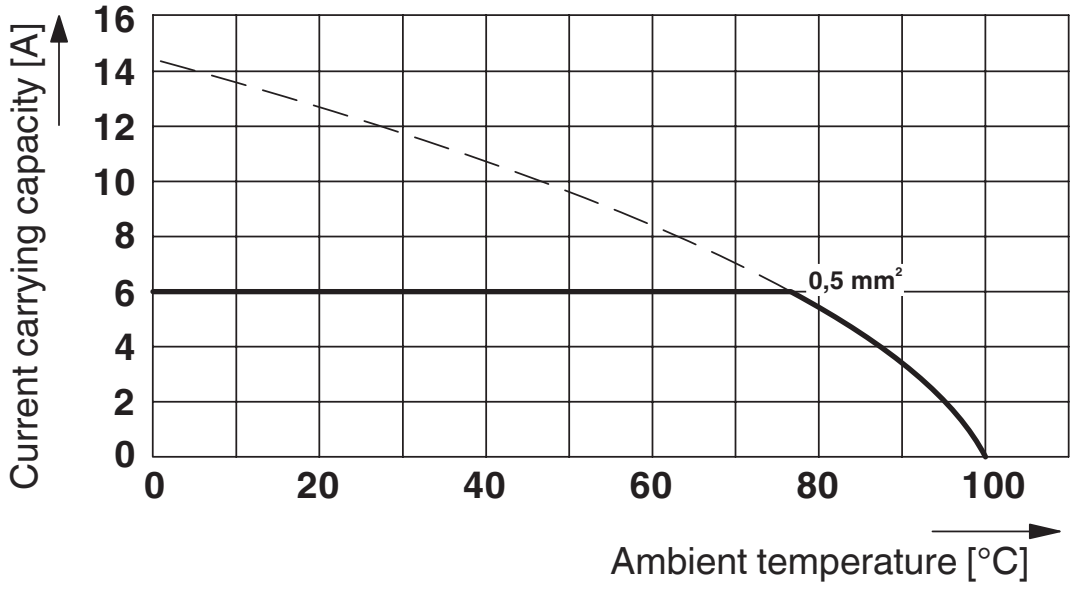
Type of packaging	packed in cardboard

Drawings

Dimensional drawing



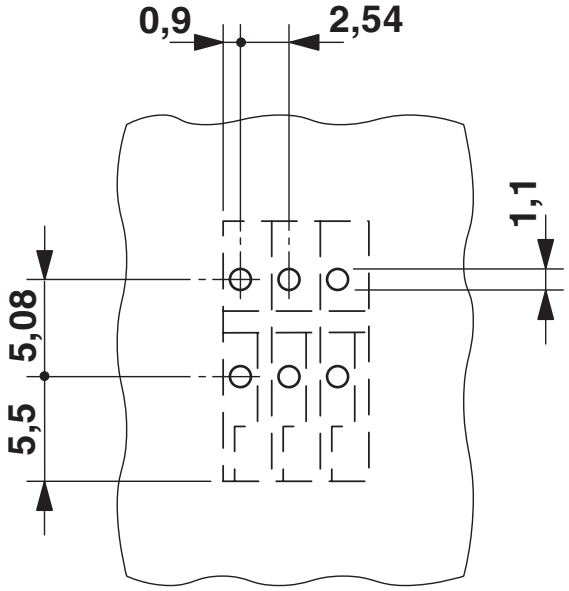
Diagram



Type: FFKDS/H-2,54

Test following DIN EN 60512-5-2:2003-01
Reduction factor = 1
No. of positions: 5

Drilling plan/solder pad geometry



Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1791826

CSA
Approval ID: 80319255

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	150 V	6 A	20	-
D				
	150 V	6 A	20	-

cULus Recognized
Approval ID: E60425-19870330

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
B				
	150 V	6 A	26 - 18	-

KEMA-KEUR
Approval ID: 2160724.01

	Nominal voltage U_N	Nominal current I_N	Cross section AWG	Cross section mm^2
keine				
	63 V	-	-	0.14 - 0.5

Classifications

ECLASS

ECLASS-13.0	27460101
ECLASS-15.0	27460101

ETIM

ETIM 10.0	EC002643

UNSPSC

UNSPSC 21.0	39121400

Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions

China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%

EF3.1 Climate Change

CO2e kg	0.051 kg CO2e

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